Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

# 2SK2599

# Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain–source ON resistance : RDS (ON) =  $2.9 \Omega$  (typ.) • High forward transfer admittance :  $|Y_{fs}| = 1.7 S$  (typ.) • Low leakage current :  $I_{DSS} = 100 \mu A$  (max) ( $V_{DS} = 500 V$ ) • Enhancement mode :  $V_{th} = 2.0 \sim 4.0 V$  ( $V_{DS} = 10 V$ ,  $I_{D} = 1 mA$ )

### Absolute Maximum Ratings (Ta = 25°C)

Charac	eteristics	Symbol	Rating	Unit	
Drain-source volta	ge	$V_{DSS}$	500	V	
Drain-gate voltage	(R <sub>GS</sub> = 20 kΩ)	$V_{DGR}$	500	V	
Gate-source voltage	ge	V <sub>GSS</sub>	±30	V	
Drain current	DC (Note 1)	ID	2	Α	
	Pulse (t = 1 ms) (Note 1)	I <sub>DP</sub>	5	Α	
	Pulse (t = 100 µs) (Note 1)	I <sub>DP</sub>	12	Α	
Drain power dissipa	ation	P <sub>D</sub>	1.3	W	
Single pulse avalar	nche energy (Note 2)	E <sub>AS</sub>	112	mJ	
Avalanche current		I <sub>AR</sub>	2	Α	
Repetitive avalanch	ne energy (Note 3)	E <sub>AR</sub>	0.13	mJ	
Channel temperatu	ire	T <sub>ch</sub>	150	°C	
Storage temperatu	re range	T <sub>stg</sub>	-55~150	°C	

1.4±0.1 1.05±0.1 1.05±0.1 1.55±0.5 2.5±0.5 2.5±0.5 1.SOURCE 2.DRAIN 3.GATE

JEDEC —

JEITA —

TOSHIBA 2-8M1B

Weight: 0.54 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	96.1	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 48.4 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = 2 \text{ A}$ 

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

2SK2<u>599</u>



## **Electrical Characteristics (Ta = 25°C)**

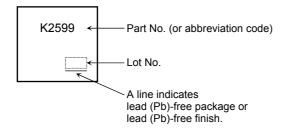
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Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	$I_{G} = \pm 10 \ \mu A, \ V_{GS} = 0 \ V$	±30	_	_	V
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>DS</sub> = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold v	voltage	$V_{th}$	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A	_	2.9	3.2	Ω
Forward transfer	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 A	0.8	1.7	_	S
Input capacitano	e	C <sub>iss</sub>			380	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	40	_	
Output capacitance		Coss		_	120	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS} \stackrel{10V}{\underset{0V}{\longrightarrow}} \stackrel{I_{D}=1A}{\underset{R_{L}=200\Omega}{\longrightarrow}} V_{out}$ $V_{DD} \stackrel{\vdots}{\rightleftharpoons} 200V$ $Duty \leq 1\%, \ t_{W} = 10 \mu s$	_	15	_	
	Turn-on time	t <sub>on</sub>		_	25	_	ne
	Fall time	t <sub>f</sub>		_	20	_	ns
	Turn-off time	t <sub>off</sub>		_	80	_	
Total gate charge (Gate-source plus gate-drain)		Qg	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2 A	_	9		nC
Gate-source charge		Q <sub>gs</sub>			5	_	
Gate-drain ("miller") charge		$Q_{gd}$		_	4	_	

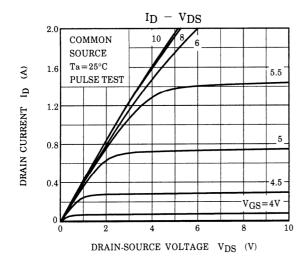
## **Source-Drain Ratings and Characteristics (Ta = 25°C)**

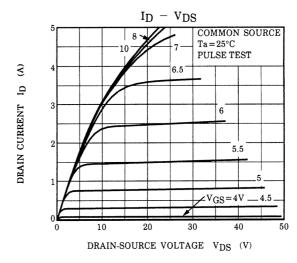
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	2	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	t = 1 ms	_	_	5	Α
	I <sub>DRP</sub>	t = 100 μs			12	Α
Forward voltage (diode)	$V_{DSF}$	I <sub>DR</sub> = 2 A, V <sub>GS</sub> = 0 V	_	_	-1.5	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 2 A, V <sub>GS</sub> = 0 V		1000	_	ns
Reverse recovered charge	Qrr	dl <sub>DR</sub> / dt = 100 A / μs		3.5	_	μC

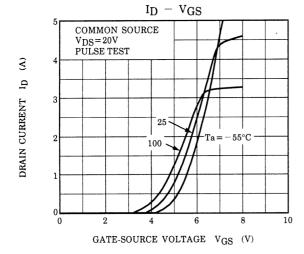
### Marking

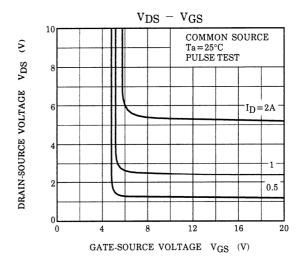


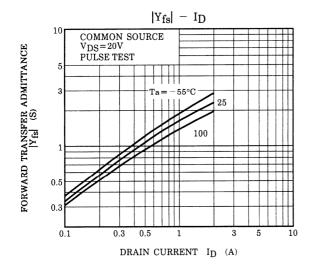
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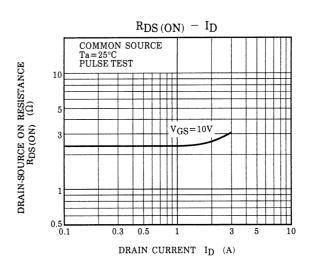


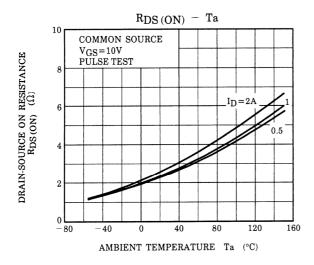


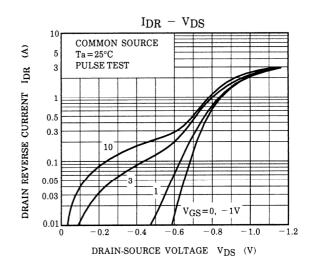


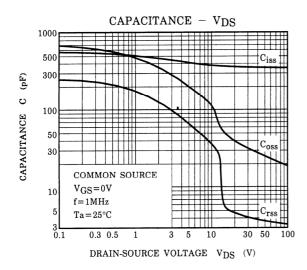


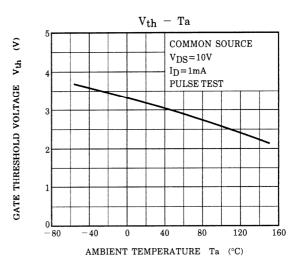


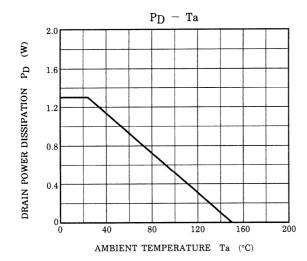


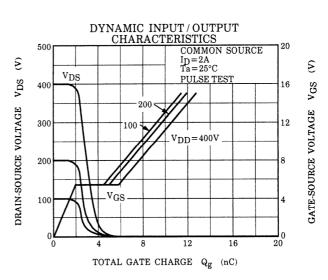


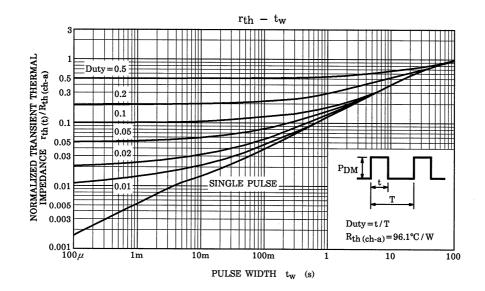


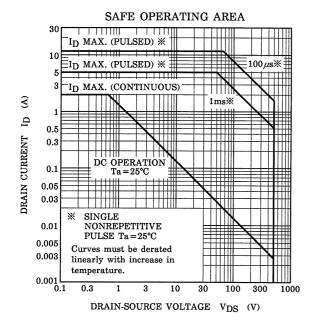


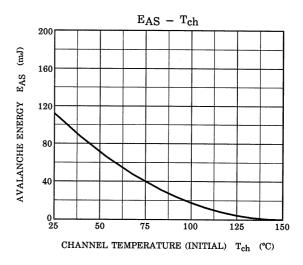


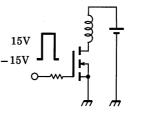


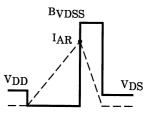












TEST CIRCUIT

WAVE FORM

$$R_G$$
 = 25  $\Omega$   
 $V_{DD}$  = 90 V, L = 48.4 mH

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$$EAS = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right)$$

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